LITEON®
OPTOELECTRONICS

Photocoupler

Product Data Sheet

6N138-L / 6N139-L Series

Spec No.: DS70-2009-0001

Effective Date: 04/12/2016

Revision: A

LITE-ON DCC

RELEASE

BNS-OD-FC001/A4

LITE-ON Technology Corp. / Optoelectronics
No.90,Chien 1 Road, Chung Ho, New Taipei City 23585, Taiwan, R.O.C.
Tel: 886-2-2222-6181 Fax: 886-2-2221-1948 / 886-2-2221-0660
http://www.liteon.com/opto

Photocoupler
6N138-L 6N139-L series

1. DESCRIPTION

These high gain series couplers use a light emitter diode and an integrated high gain photo detector to provide extremely high current transfer ratio between input and output. Separate pins for the photodiode and output stage result in TTL compatible saturation voltage and high speed operation. Where desired the Vcc and Vo terminals may be tied together to achieve conventional photo Darlington operation. A base access terminal allows a gain bandwidth adjustment to be made.

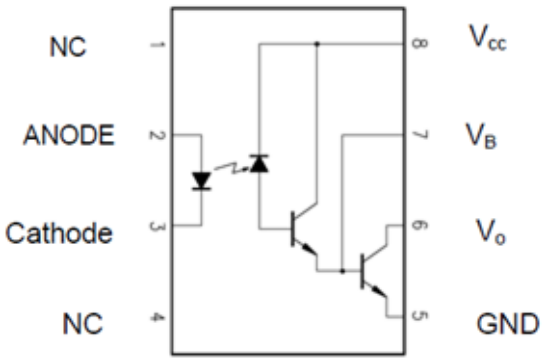
1.1 Features

- High current transfer ratio – 2000% typical.
- Low input current requirements – 0.5mA
- High output current – 60mA
- CTR guarantee – 0~70℃.
- Instantaneous common mode rejection 10KV/μsec
- TTL compatible output – 0.1V V_{OL} typical
- UL, CSA approved.

1.2 Applications

- Digital logic ground isolation
- Low input current line receiver
- Telephone ring detector
- EIA-RS-232C line receiver
- Current loop receiver
- High common mode noise line receiver

1.3 Functional Diagram



A 0.1μF bypass Capacitor must be connected between Pin8 and Pin5

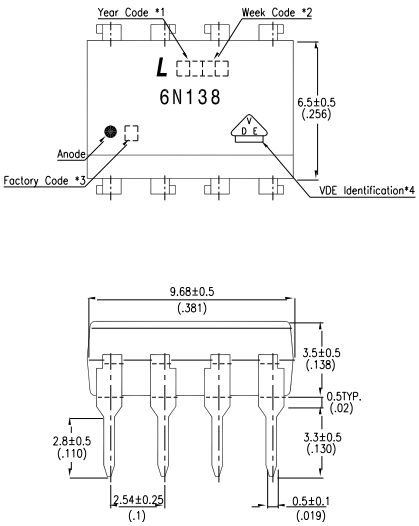
Truth Table (Positive Logic)

LED	OUT
ON	L
OFF	H

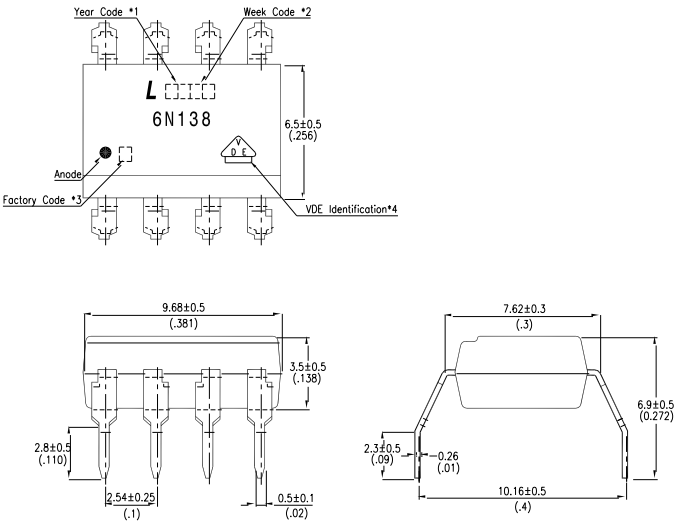
Photocoupler
6N138-L 6N139-L series

2. PACKAGE DIMENSIONS

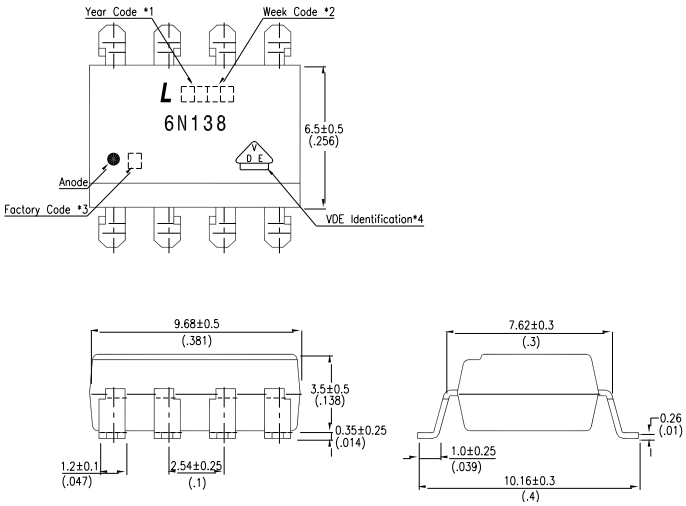
2.1 6N138-L



2.2 6N138M-L



2.3 6N138S-L



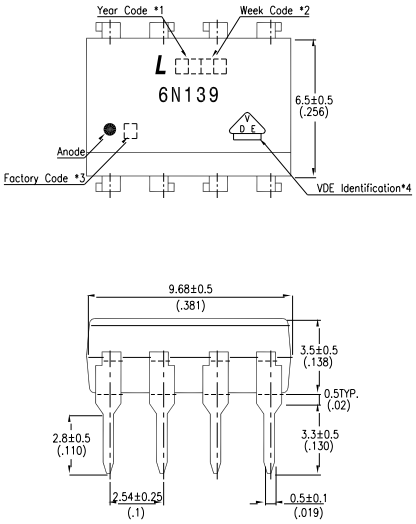
Notes :

1. Year date code.
2. 2-digit work week.
3. Factory identification mark shall be marked (Y: Thailand , W: China-CZ)
4. For VDE option.

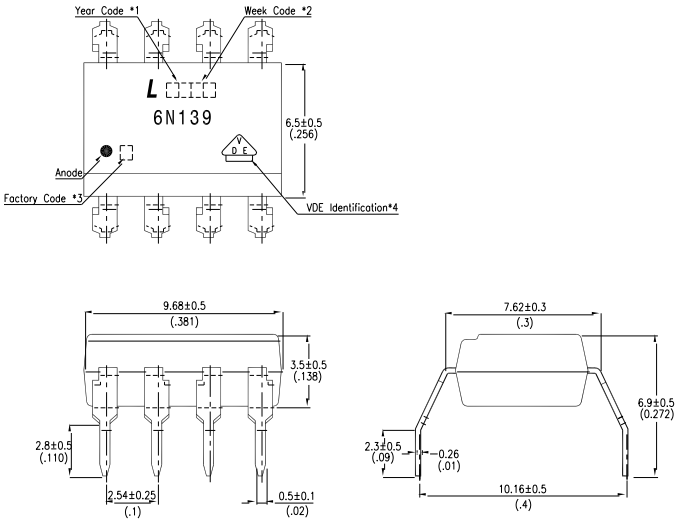
Dimensions in millimeters (inches).

Photocoupler
6N138-L 6N139-L series

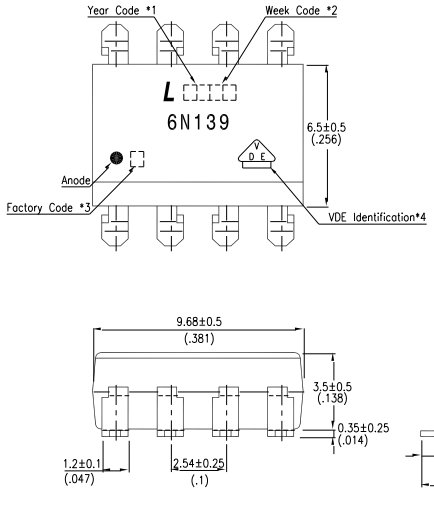
2.4 6N139-L



2.5 6N139M-L



2.6 6N139S-L



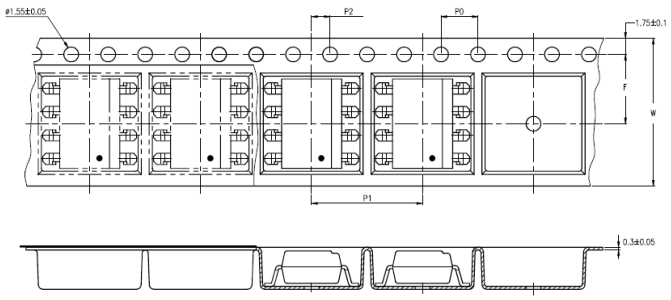
Notes :

1. Year date code.
2. 2-digit work week.
3. Factory identification mark shall be marked (Y: Thailand , W: China-CZ)
4. For VDE option.

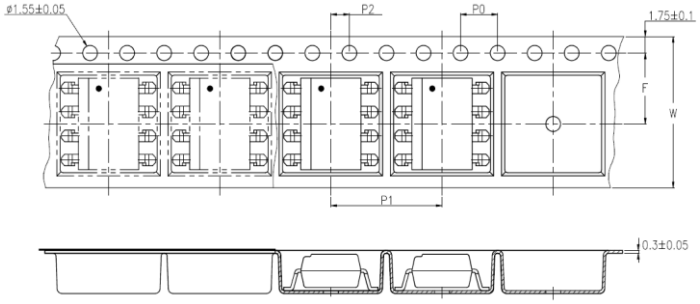
Dimensions in millimeters (inches).

3. TAPING DIMENSIONS

3.1 6N138S-TA-L/ 6N139S-TA-L



3.2 6N138S-TA1-L/ 6N139S-TA1-L



Description	Symbol	Dimension in mm (inch)
Tape wide	W	16±0.3 (0.63)
Pitch of sprocket holes	P_0	4±0.1 (0.15)
Distance of compartment	F	7.5±0.1 (0.295)
	P_2	2±0.1 (0.079)
Distance of compartment to compartment	P_1	12±0.1 (0.472)

3.3 Quantities Per Reel

Package Type	TA / TA1
Quantities (pcs)	1000

4. RATING AND CHARACTERISTICS

4.1 Absolute Maximum Ratings at Ta=25°C *1

	Parameter		Symbol	Rating	Unit	Note
Input	Average Forward Input Current		I_F	20	mA	2
	Reverse Input Voltage		V_R	5	V	
	Power Dissipation		P_I	35	mW	
Output	Output Collector Current		I_O	50	mA	
	Output Voltage	6N138	V_O	7	V	
		6N139		18		
	Output Collector Power Dissipation		P_o	100	mW	
	Isolation Voltage		V_{iso}	5000	V_{rms}	
	Supply Voltage	6N138	V_{CC}	7	V	
		6N139		18		
	Operating Temperature		T_{opr}	-40 ~ +85	°C	
	Storage Temperature		T_{stg}	-55 ~ +125	°C	
	Lead Solder Temperature *2		T_{sol}	260	°C	

1. Ambient temperature = 25°C, unless otherwise specified. Stresses exceeding the absolute maximum ratings can cause permanent damage to the device. Exposure to absolute maximum ratings for long periods of time can adversely affect reliability.

2. 260°C for 10 seconds. Refer to Lead Free Reflow Profile.

4.2 ELECTRICAL CHARACTERISTICS at Ta = 25°C

Parameters	Test Condition	Symbol	Device	Min	Typ	Max	Units
Input							
Input Forward Voltage	I_F =1.6mA, T_A=25℃	V_F	6N138 6N139		1.1	1.7	V
Input Forward Voltage Temperature Coefficient	IF=1.6mA	$\Delta V_F/\Delta T_A$			-1.9		mV/℃
Input Reverse Voltage	I_R = 10μA T_A=25℃	BV_R		5	-	-	V
Input Capacitance	V_F=0; f=1MH$_Z$	C_{IN}		-	60	-	pF
Detector							
Current transfer ratio	I_F=1.6mA; Vo=0.4V; Vcc=4.5V	CTR	6N138	300	1600	2600	%
	I_F=0.5mA; Vo=0.4V; Vcc=4.5V		6N139	400	2000	5000	
	I_F=1.6mA; Vcc=0.4V; Vcc=4.5V			500	1600	2600	
Logic low output voltage	I_F=1.6mA; Vcc=4.5V; I_o=4.8mA	V_{OL}	6N138	-	0.1	0.4	V
	I_F=0.5mA; Vcc=4.5V; I_o=2mA		6N139	-	0.1	0.4	
	I_F=1.6mA; Vcc=4.5V; I_o=8mA						
	I_F=5mA; Vcc=4.5V; I_o=15mA						
	I_F=12mA; Vcc=4.5V; I_o=24mA			-	0.2		
Logic high output current	I_F=0mA, Vo=Vcc=7V; T_A=25℃	I_{OH}	6N138	-	0.05	250	μA
	I_F=0mA, Vo=Vcc=18V; T_A=25℃		6N139	-	0.1	100	
Logic low supply current	I_F=1.6mA, V_o=open (Vcc=18V)	I_{ccL}	6N138 6N139	-	0.4	1.5	mA
Logic high supply current	I_F=0mA, V_o=open ; T_A=25℃ (Vcc=18V)	I_{ccH}	6N138 6N139	-	0.01	10	mA

Specified over recommended temperature (T_A = -40°C to +85°C, 4.5V ≤ V_{CC} ≤ 5.5V), I_F = 7.5mA unless otherwise specified. All typicals at T_A = 25°C, V_{CC} = 5.0V.

5. SWITCHING SPECIFICATIONS (AC)

Parameter	Test Condition	Symbol	Device	Min	Typ	Max	Units
Propagation Delay Time to Low Output Level	I_F=1.6mA; R_L= 2.2kΩ	t_{PHL}	6N138	-	1.6	10	μs
	I_F=0.5mA; R_L=4.7KΩ		6N139	-	5	25	
	I_F=12mA; R_L=270Ω			-	0.1	1	
Propagation Delay Time to High Output Level	I_F=1.6mA; R_L= 2.2kΩ	t_{PLH}	6N138	-	10	35	μs
	I_F=0.5mA; R_L=4.7KΩ		6N139	-	18	60	
	I_F=12mA; R_L=270Ω			-	2	7	
Logic High Common Mode Transient Immunity	I_F=0mA; $\|V_{CM}\|$=10V_{p-p} R_L=2.2KΩ	$\|CM_H\|$	6N138	1	10	-	KV/μs
			6N139				KV/μs
Logic Low Common Mode Transient Immunity	I_F=1.6mA; $\|V_{CM}\|$=10V_{p-p} R_L=2.2KΩ	$\|CM_L\|$	6N138	1	10	-	KV/μs
			6N139				KV/μs

*All Typical at T_A=25°C

6. ISOLATION CHARACTERISTIC

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Input-Output Insulation Leakage Current	I_{I-O}	—	—	1.0	μA	45% RH, t = 5s, V_{I-O} = 3kV DC, T_A =25°C
Withstand Insulation Test Voltage	V_{ISO}	5000	—	—	V_{RMS}	RH ≤ 50%, t = 1min, T_A = 25°C
Input-Output Resistance	R_{I-O}	—	10^{12}	—	Ω	V_{I-O} = 500V DC

*All Typical at T_A=25°C

Notes

1. AC For 1 Minute, R.H. = 40 ~ 60%. Isolation voltage shall be measured using the following method.

(1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.

(2) The isolation voltage tester with zero-cross circuit shall be used.

(3) The waveform of applied voltage shall be a sine wave.

2. For 10 Seconds

3. Current Transfer Ratio (CTR) is defined as the ration of output collector current, Io, to the forward LED input current, IF, times 100%.

4. Pin 7 open.

5. Instantaneous common mode rejection voltage "output (1)" represents a common mode voltage variation that can hold the output above (1) level (Vo>2.0V).Instantaneous common mode rejection voltage "output (0)" represents a common mode voltage variation that can hold the output above (0) level (Vo<0.8V).

6. Device considered a two terminal device. Pins 1, 2, 3 and 4 shorted together and Pins 5, 6, 7 and 8 shorted together.

7. SWITCHING TIME TEST CIRCUIT

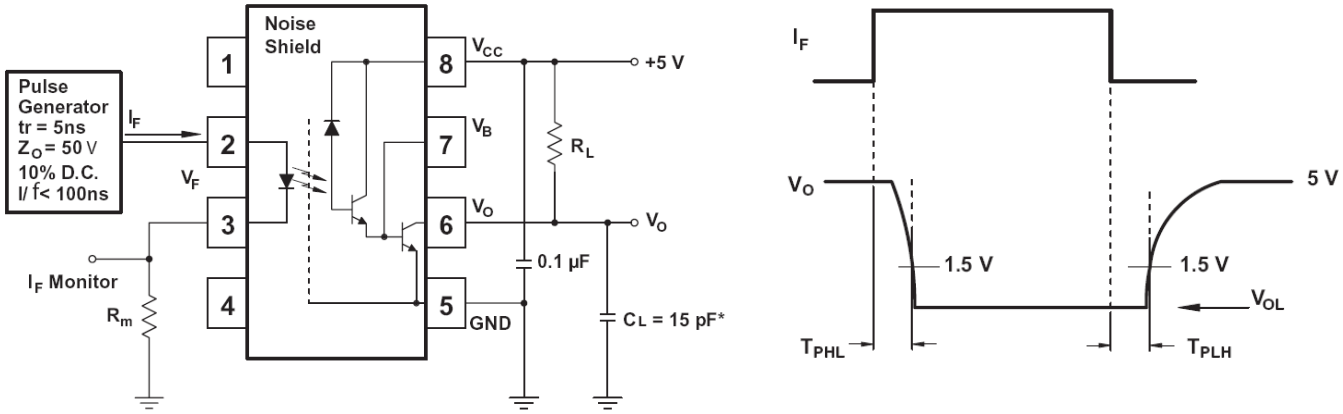


Figure 1: Single Channel Test Circuit for t_{PHL} and t_{PLH}

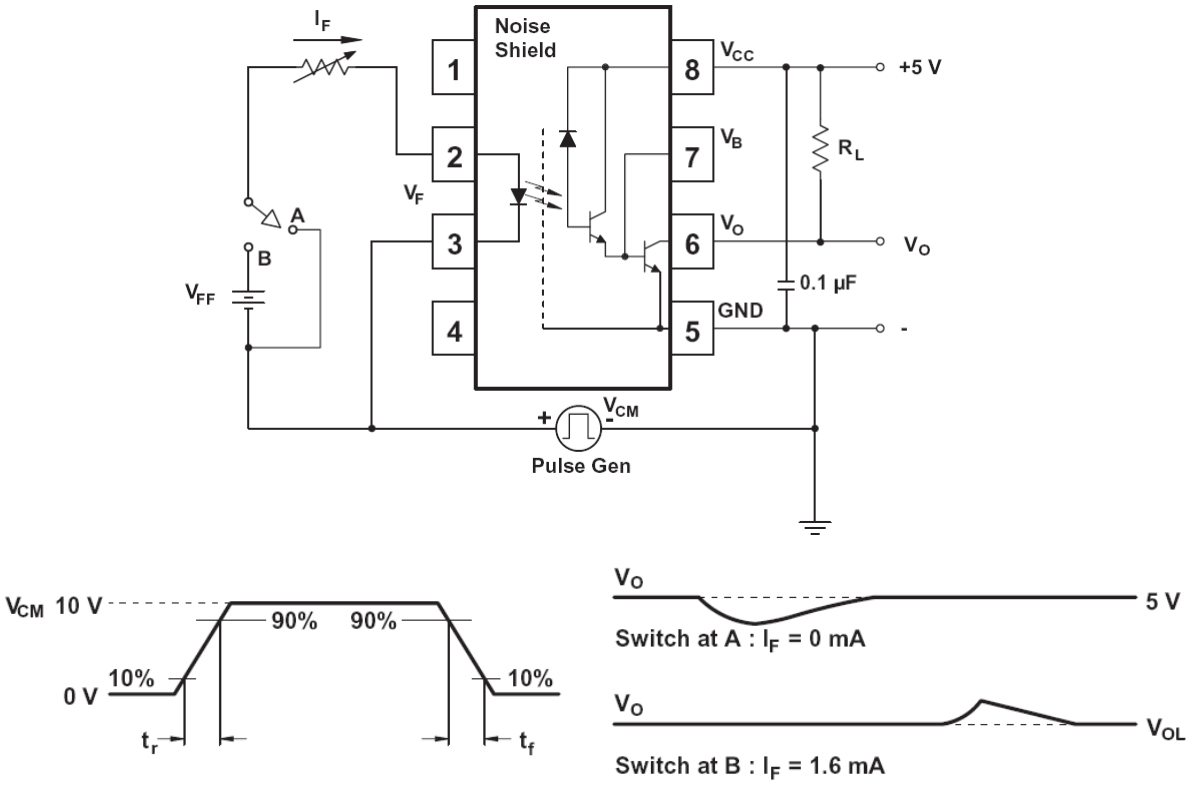


Figure 2: Single Channel Test Circuit for Common Mode Transient Immunity

8. CHARACTERISTIC CURVES

Figure 3: DC transfer characteristics

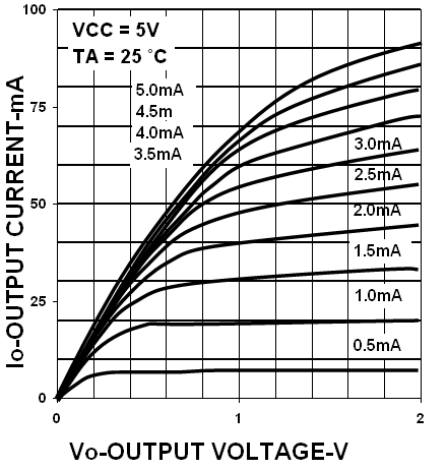


Figure 4: output current vs. input diode forward

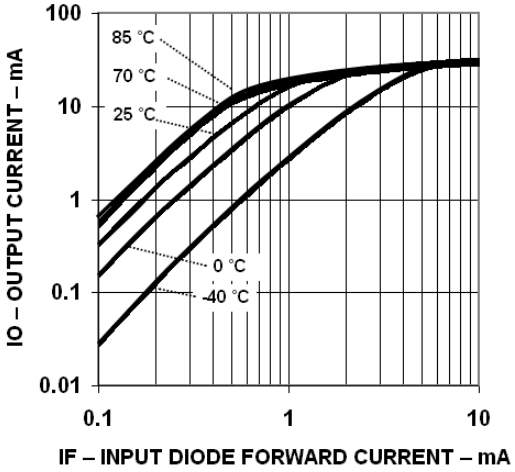


Figure 5: 6N139 propagation delay vs. temperature

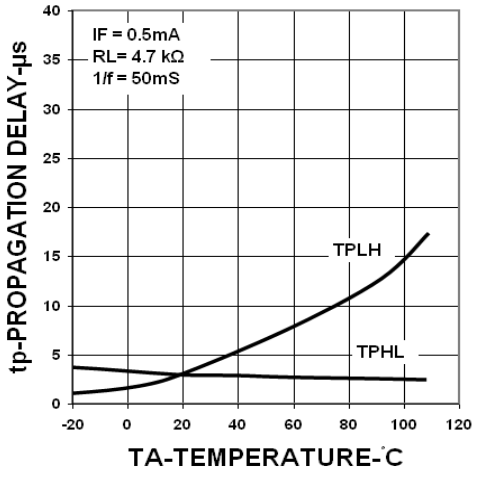


Figure 6: current transfer ratio vs. forward current

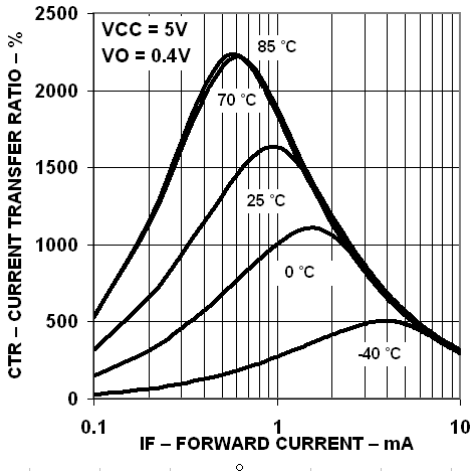


Figure 7: current transfer ratio vs. forward current

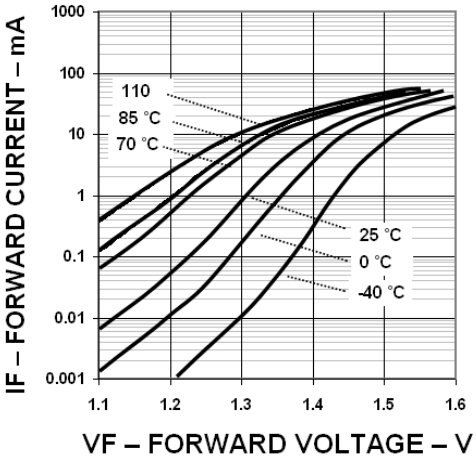


Figure 8: 6N138 propagation delay vs. temperature

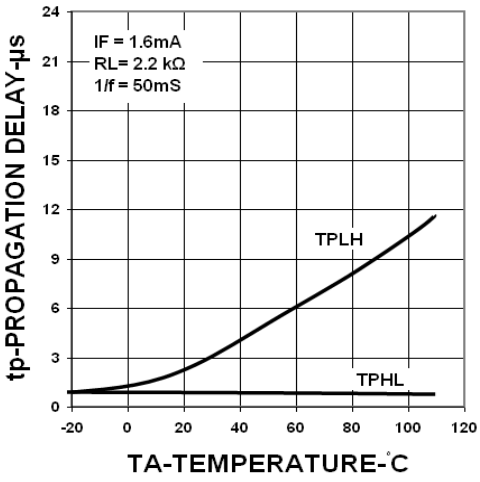


Figure 9: 6N139 propagation delay vs. temperature

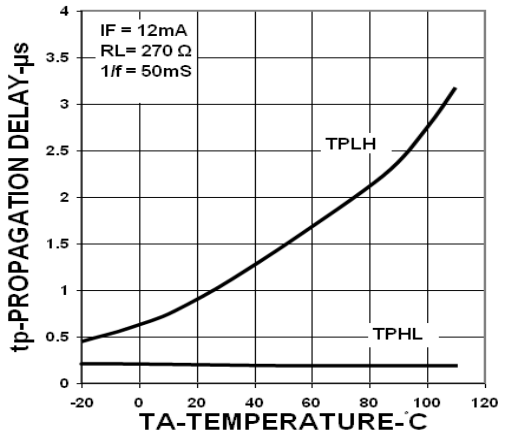


Figure 10: Nonsaturated rise and fall time vs. load resistance

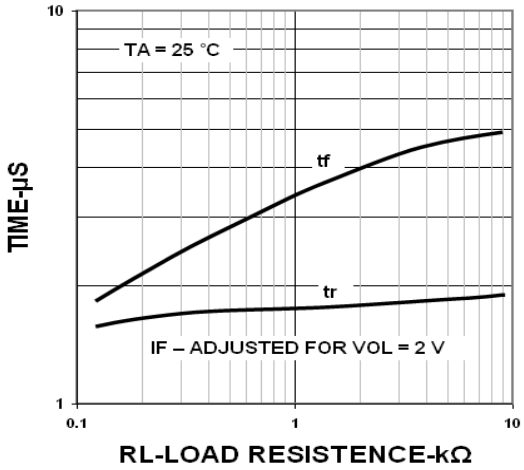


Figure 11: Forward voltage vs. temperature

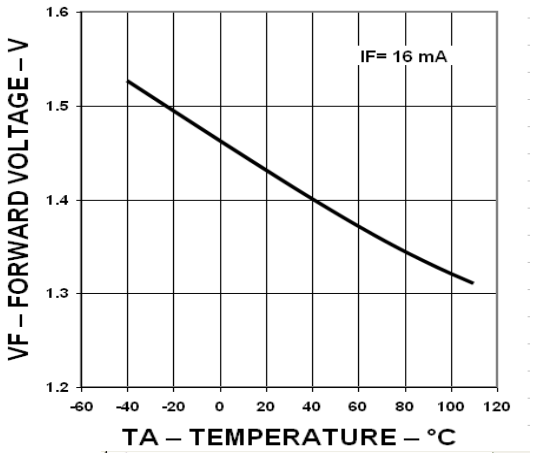
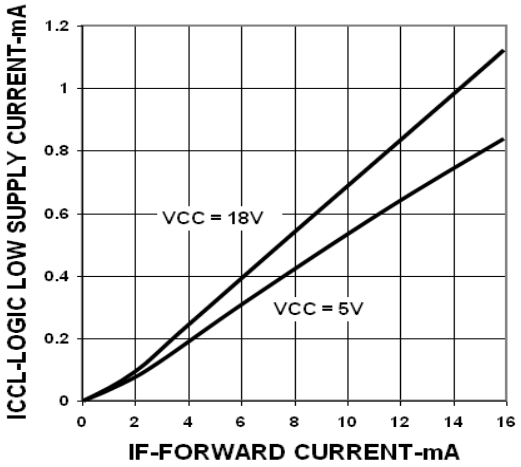


Figure 12: Logic low supply current vs. forward current

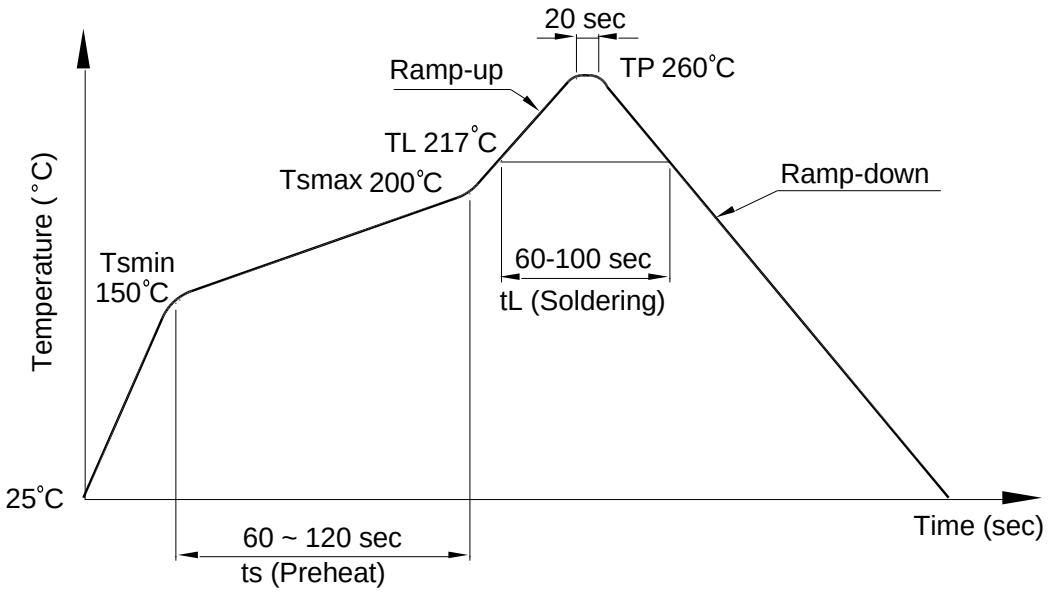


9. TEMPERATURE PROFILE OF SOLDERING

9.1 IR Reflow soldering (JEDEC-STD-020C compliant)

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.

Profile item	Conditions
Preheat	
- Temperature Min (T_{Smin})	150˚C
- Temperature Max (T_{Smax})	200˚C
- Time (min to max) (ts)	90±30 sec
Soldering zone	
- Temperature (T_L)	217˚C
- Time (t_L)	60 ~ 100 sec
Peak Temperature (T_P)	260˚C
Ramp-up rate	3˚C / sec max.
Ramp-down rate	3~6˚C / sec



9.2 Wave soldering (JEDEC22A111 compliant)

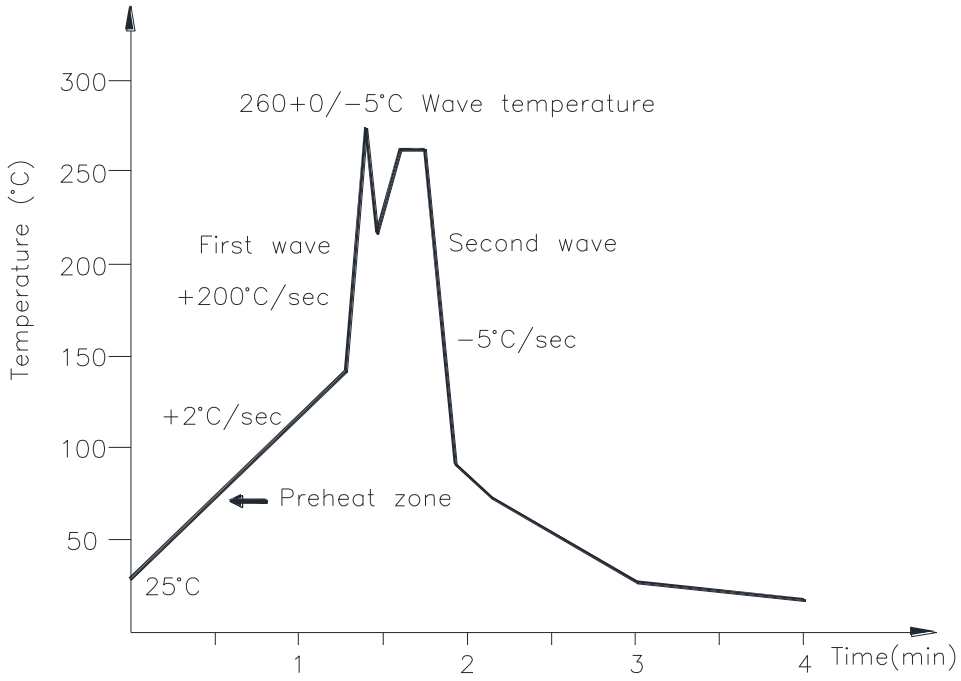
One time soldering is recommended within the condition of temperature.

Temperature: 260+0/-5˚C

Time: 10 sec.

Preheat temperature:25 to 140˚C

Preheat time: 30 to 80 sec.



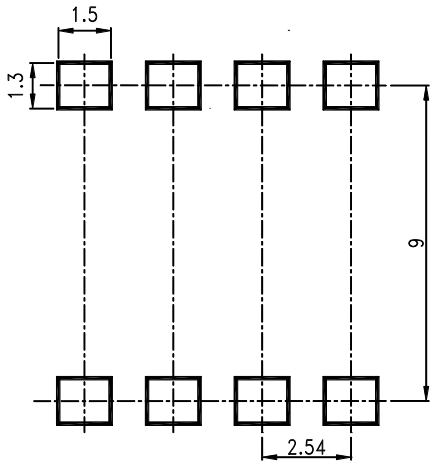
9.3 Hand soldering by soldering iron

Allow single lead soldering in every single process. One time soldering is recommended.

Temperature: 380+0/-5˚C

Time: 3 sec max.

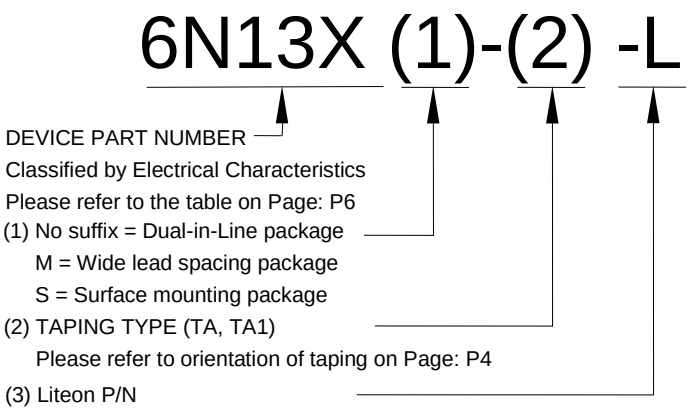
10. RECOMMENDED FOOT PRINT PATTERNS (MOUNT PAD)



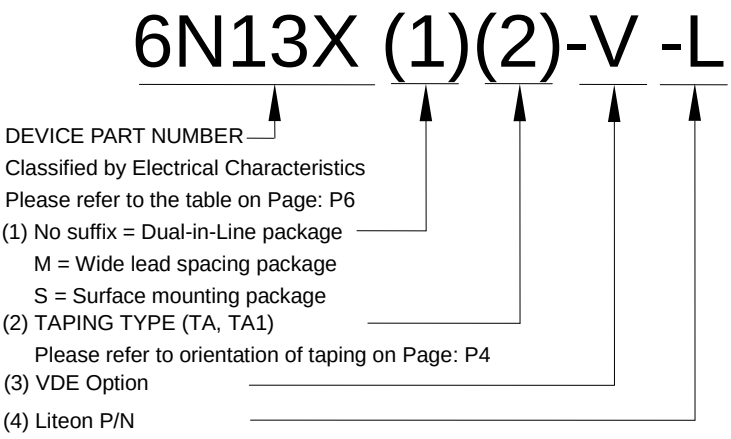
Note :

Dimensions in millimeters.

11. NAMING RULE



Example : 6N138S-TA1-L , 6N139S-TA1-L



Example : 6N138STA1-V-L , 6N139STA1-V-L

12. NOTES

- LiteOn is continually improving the quality, reliability, function or design and LiteOn reserves the right to make changes without further notices.
- The products shown in this publication are designed for the general use in electronic applications such as office automation equipment, communications devices, audio/visual equipment, electrical application and instrumentation.
- For equipment/devices where high reliability or safety is required, such as space applications, nuclear power control equipment, medical equipment, etc, please contact our sales representatives.
- When requiring a device for any “specific” application, please contact our sales in advice.
- If there are any questions about the contents of this publication, please contact us at your convenience.
- The contents described herein are subject to change without prior notice.
- Immerge unit’s body in solder paste is not recommended.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for High Speed Optocouplers ***category:***

Click to view products by Lite-On ***manufacturer:***

Other Similar products are found below :

6N136F PS8502L2-AX ACNW261L-000E ACPL-344JT-000E ACPL-K49T-500E ACPL-K75T-000E ACPL-W21L-560E ACPL-K44T-500E TLP187(TPL,E(T TLP2601(TP1,F) 610737H 6N137A-X001 6N137A-X017T 6N139-X007T HCPL2630M HCPL2731SM TLP555(F) HCPL2630SM PS2841-4A-F3-AX PS9817A-1-F3-AX PS9821-2-F3-AX ORPC-817D ORPC-817M/C ORPC-817M/B PT17-51C/L129(BIN2) TLP521-4GBSM UMW817C 6N137S1(TA) TLP521GB TLP521GB-S PS2501 PS2501-S TLP785GB TLP785GB-S LTV-214-G TLP2766A(E TLP2766A(LF4,E LCR-0202 EL814S1(TA)-V PC817X4NSZ2B CYPC817 OR-MOC3023 TLP267J(TPL,E(T TLP109(TPL,E(O EL2514S1(TU)(CLW)-G EL816S2(C)(TU)-F TLP281-4 MOC3023M ACPL-K49T-060E ACPL-K75T-500E